SN54ALS245A, SN54AS245, SN74ALS245A, SN74AS245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SDAS272A - NOVEMBER 1994 - REVISED JANUARY 2003

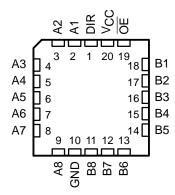
- 4.5-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 5.5 ns at 5 V

SN54ALS245A . . . J OR W PACKAGE SN54AS245 . . . J PACKAGE SN74ALS245A . . . DB, DW, N, OR NS PACKAGE SN74AS245 . . . DW, N, OR NS PACKAGE

> (TOP VIEW) 20 🛮 V_CC DIR [А1 [19 OE 18**∏** B1 A2 **∏**3 17 B2 A3 [16**∏** B3 А4 Г A5 [15**∏** B4 14**∏** B5 A6 [13**∏** B6 A7 **∏**8 A8 **∏**9 12 B7 GND [] 10 11 B8

- 3-State Outputs Drive Bus Lines Directly
- pnp Inputs Reduce dc Loading

SN54ALS245A, SN54AS245 . . . FK PACKAGE (TOP VIEW)



description/ordering information

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
			SN74ALS245A-1N	SN74ALS245A-1N
	PDIP – N	Tube	SN74ALS245AN	SN74ALS245AN
			SN74AS245N	SN74AS245N
		Tube	SN74ALS245ADW	ALS245A
		Tape and reel	SN74ALS245ADWR	AL3243A
	SOIC - DW	Tube	SN74ALS245A-1DW	ALS245A-1
0°C to 70°C	SOIC - DW	Tape and reel	SN74ALS245A-1DWR	AL3243A-1
		Tube	SN74AS245DW	AS245
		Tape and reel	SN74AS245DWR	A3243
		Tape and reel	SN74ALS245ANSR	ALS245A
	SOP – NS	Tape and reel	SN74ALS245A-1NSR	ALS245A-1
		Tape and reel	SN74AS245NSR	74AS245
	SSOP – DB	Tape and reel	SN74ALS245ADBR	G245A
	CDIP – J	Tube	SNJ54ALS245AJ	SNJ54ALS245AJ
	CDIF = 3	Tube	SNJ54AS245J	SNJ54AS245J
–55°C to 125°C	CFP – W	Tube	SNJ54ALS245AW	SNJ54ALS245AW
	LCCC – FK	Tube	SNJ54ALS245AFK	SNJ54ALS245AFK
	LCCC - FK TUDE		SNJ54AS245FK	SNJ54AS245FK



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SN54ALS245A, SN54AS245, SN74ALS245A, SN74AS245 **OCTAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS

SDAS272A - NOVEMBER 1994 - REVISED JANUARY 2003

description/ordering information(continued)

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

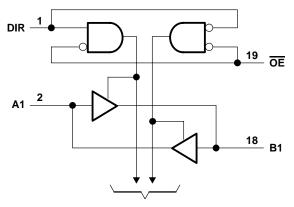
The devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated.

The -1 version of the SN74ALS245A is identical to the standard version, except that the recommended maximum I_{OI} is increased to 48 mA. There is no -1 version of the SN54ALS245A.

FUNCTION TABLE

INP	UTS	OPERATION					
ŌĒ	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
Н	Χ	Isolation					

logic diagram, each gate (positive logic)



To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (SN54ALS245A, SN74ALS245A) (unless otherwise noted)†

Supply voltage, V _{CC}		7 V
Input voltage, V _I : All inputs		7 V
I/O ports		5.5 V
Package thermal impedance, θ _{JA} (see Note 1)	: DB package	70°C/W
-	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
Storage temperature range		. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.



SN54ALS245A, SN54AS245, SN74ALS245A, SN74AS245 **ÓCTAL BUS TRÁNSCEIVERS** WITH 3-STATE OUTPUTS

SDAS272A - NOVEMBER 1994 - REVISED JANUARY 2003

recommended operating conditions (see Note 2)

		SN54ALS245A			SN7	5A	UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vсс	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
ІОН	High-level output current			-12			-15	mA
l _a .	Low-level output current			12			24	mA
lOL							48†	IIIA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COL	TEST CONDITIONS		4ALS24	5A	SN74ALS245A			LINUT	
	PARAMETER TEST CONDITION			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
٧ıĸ		V _{CC} = 4.5 V,	I _I = -18 mA			-1.5			-1.5	V	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2	1			
\ _{\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\}			$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V	
∨он		V _{CC} = 4.5 V	$I_{OH} = -12 \text{ mA}$	2						V	
			$I_{OH} = -15 \text{ mA}$				2				
			I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
VOL		V _{CC} = 4.5 V	I _{OL} = 24 mA					0.35	0.5	V	
			$I_{OL} = 48 \text{ mA}^{\dagger}$					0.35	0.5		
1.	Control inputs	V	V _I = 7 V			0.1			0.1	mA	
1	A or B ports	V _{CC} = 5.5 V	V _I = 5.5 V			0.1			0.1	ША	
	Control inputs	Vac 55V	V. 27V			20			20	4	
lін	A or B ports§	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
Ī	Control inputs	Vac 55V	V: 0.4.V			-0.1			-0.1	mA	
lı∟	A or B ports§	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA	
Io¶		V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA	
			Outputs high		30	48		30	45		
Icc		V _{CC} = 5.5 V	Outputs low		36	60		36	55	mA	
			Outputs disabled		38	63		38	58		

 $^{^\}dagger$ Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V



[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

[‡] All typical values are $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, IOS.

SN54ALS245A, SN54AS245, SN74ALS245A, SN74AS245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SDAS272A - NOVEMBER 1994 - REVISED JANUARY 2003

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _i R'	L = 50 pl 1 = 500 <u>9</u> 2 = 500 <u>9</u>	Ω,	V,	UNIT
			SN54ALS245A		SN74ALS245A		
			MIN	MAX	MIN	MAX	
t _{PLH}	A or B	B or A	1	19	3	10	ns
^t PHL	AUD	BOIA	1	14	3	10	115
^t PZH	ŌĒ	A or B	2	30	5	20	ns
t _{PZL}	OE	AOIB	2	29	5	20	115
^t PHZ	ŌĒ	A or B	2	14	2	10	ns
^t PLZ	OE	A OI D	2	30	4	15	113

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (SN54AS245, SN74AS245) (unless otherwise noted)[‡]

Supply voltage, V _{CC}	7 V
Input voltage, V _I : All inputs	7 V
I/O ports	5.5 V
Package thermal impedance, θ_{JA} (see Note 1): DW package	58°C/W
N package	69°C/W
NS package	60°C/W
Storage temperature range	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 2)

		SN54AS245			SN	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I _{ОН}	High-level output current			-12			-15	mA
loL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SN54ALS245A, SN54AS245, SN74ALS245A, SN74AS245 **ÓCTAL BUS TRÁNSCEIVERS WITH 3-STATE OUTPUTS**

SDAS272A - NOVEMBER 1994 - REVISED JANUARY 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED	TEST COL	UDITIONS	AS .	SN54AS245			SN74AS245			
	PARAMETER	TEST CONDITIONS		MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT	
٧ıK		$V_{CC} = 4.5 \text{ V},$	I _I = –18 mA			-1.2			-1.2	V	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	I _{OH} = −2 mA	V _{CC} -2	2		V _{CC} -2	2			
Va			$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V	
VOH		$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -12 \text{ mA}$	2						V	
			$I_{OH} = -15 \text{ mA}$				2				
V0.		V _{CC} = 4.5 V	I _{OL} = 48 mA		0.3	0.55				V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$					0.35 0.55		·	
ļ	Control inputs	V _{CC} = 5.5 V	V _I = 7 V			0.1			0.1	mA	
11	A or B ports	VCC = 5.5 V	V _I = 5.5 V			0.1			0.1	Ш	
ļ	Control inputs	V _{CC} = 5.5 V,	V _I = 2.7 V			50			20	μΑ	
ΊΗ	A or B ports [‡]	VCC = 5.5 v,	V - 2.7 V			70			70	μΛ	
ļ	Control inputs	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.5			-0.5	mA	
ΊL	A or B ports‡	VCC = 5.5 V,	V = 0.4 V	7] = 0.4 V -0.75		-0.75	-0.75		-0.75] IIIA	
ΙΟ§		$V_{CC} = 5.5 \text{ V},$	V _O = 2.25 V	-50		-150	-50		-150	mA	
			Outputs high		62	97		62	97		
ICC		V _{CC} = 5.5 V	Outputs low		95	143		95	143	mA	
			Outputs disabled		79	123		79	123		

switching characteristics (see Figure 1)

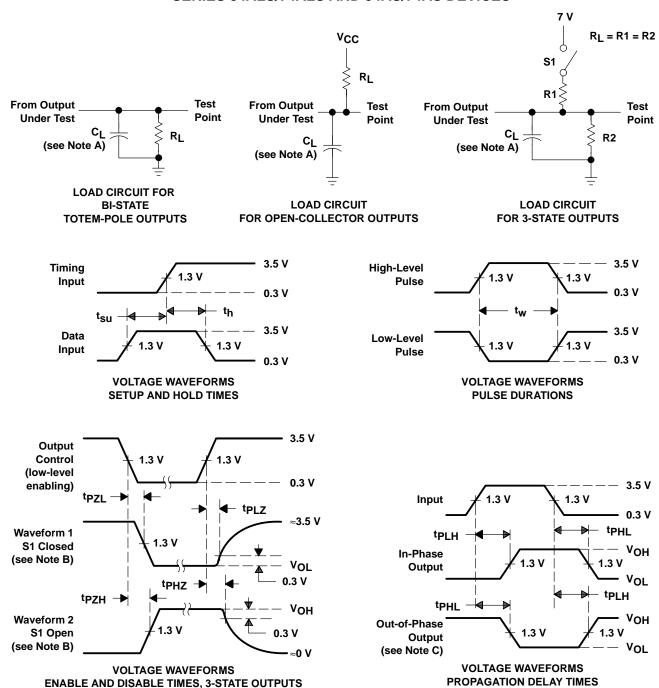
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX¶				
			SN54AS245		SN74AS245		
			MIN	MAX	MIN	MAX	
^t PLH	A or B	B or A	2	9.5	2	7.5	ns
^t PHL	AUID	BULA	2	9	2	7	115
^t PZH	ŌĒ	A or B	2	11	2	9	ns
^t PZL	ÜE	AUID	2	10.5	2	8.5	115
^t PHZ	ŌĒ	A or B	2	7.5	2	5.5	ns
^t PLZ	OE .	7010	2	12	2	9.5	115

[¶]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are V_{CC} = 5 V, T_A = 25°C.
‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.
§ The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS}.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 - D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms









PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
84030012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8403001RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
8403001SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SN54ALS245AJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54AS245J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN74ALS245ADBLE	OBSOLETE	SSOP	DB	20		None	Call TI	Call TI
SN74ALS245ADBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS245ADW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS245ADWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS245AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS245AN3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74ALS245ANSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS245DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74AS245DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74AS245N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS245NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS245AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS245AJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS245AW	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS245FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS245J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

28-Feb-2005

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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